

# SMT POWER INDUCTOR

## Toroid HCCI-80 Series

Ruggedized



- Height: 12.7mm MAX
- Footprint: 31mm x 25.4mm MAX
- Current Rating: up to 38A
- Operating Temperature: -55°C to +130°C
- Lead Finish: Sn63/Pb37
- Moisture Sensitivity Level: 1

### Electrical Specifications @ 25°C

Part Number	Parallel Rating						Series Rating						Core Loss Factor (K2)	Temp. Rise Factor (K3)		
	Inductance @ Irated (μH)	Irated (A)	DCR (mΩ)		Inductance @ 0 ADC (μH)	ET REF <sup>2</sup> (Volt-μsec)	Flux Density Factor (K1)	Inductance @ Irated (μH)	Irated (A)	DCR (mΩ)		Inductance @ 0 ADC (μH)			ET REF <sup>2</sup> (Volt-μsec)	Flux Density Factor (K1)
			TYP	MAX						TYP	MAX					
PL8304	1.10	38	1.1	1.3	2.1	4.20	0.62	4.30	19	4.4	5.1	8.4	8.40	0.31	1.50E-09	33.8
PL8303	1.60	34	1.4	1.6	3.5	4.20	0.48	6.40	17	5.6	6.4	13.8	8.40	0.24	1.50E-09	33.8
PL8302	2.45	27	2.2	2.5	5.1	6.00	0.39	9.80	13.5	8.8	10.1	20.4	12.00	0.20	1.50E-09	33.8
PL8301	3.20	24	3.0	3.5	7.2	4.20	0.33	12.80	12	12.0	13.8	28.7	8.40	0.17	1.50E-09	33.8
PL8300	4.52	19	4.2	4.8	9.5	9.00	0.29	18.10	9.5	16.8	19.3	38.0	18.00	0.14	1.50E-09	33.8

### NOTES:

1. Add suffix "NL" for RoHS compliant version; i.e. PL8304 becomes **PL8304NL**. NL parts have 100% SN Lead Finish (MSL:4)
2. For Tape & Reel packaging, add "T" suffix at the end of the part number: i.e. **PL8304T**.
3. Temperature rise is 55°C in typical buck or boost circuits operating at 300kHz with rated Idc current and reference applied to inductor.
4. Total inductor loss is 1.8W for 55°C temperature rise above ambient.
5. In high volt-time applications, additional heating in the component can occur due to core losses in the inductor which may necessitate derating the current in order to limit the temperature rise of the component. In order to determine the approximate total losses (or temperature rise) for a given application, both copper and core losses should be taken into account.

Estimated Temperature Rise:

$$\begin{aligned} \text{Trise} &= K3 \& \text{ (Coreloss(W) + Copperloss(W))}^{0.833} \text{ (C)} \\ \text{CopperLoss} &= \text{Irms}^2 \& \text{ DCR\_Typical(mW)} / 1000 \\ \text{CoreLoss} &= K2 \& \text{ (Freq\_kHz)}^{1.26} \& \text{ (DB)}^{2.11} \\ \Delta B &= K1 \& \text{ Volt-}\mu\text{sec} \& 100 \end{aligned}$$

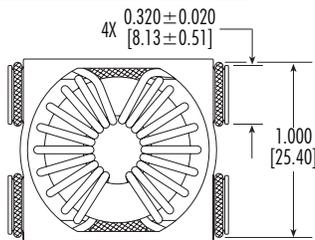
### Mechanicals

### Electrical Schematics

PL83XX

Dimensions: inch [mm]

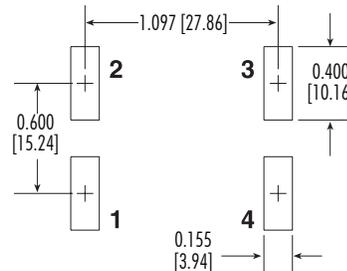
Tolerance (unless otherwise specified): ±0.010 [0.25]



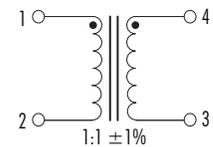
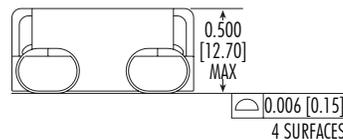
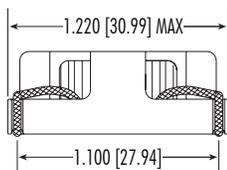
BOTTOM VIEW



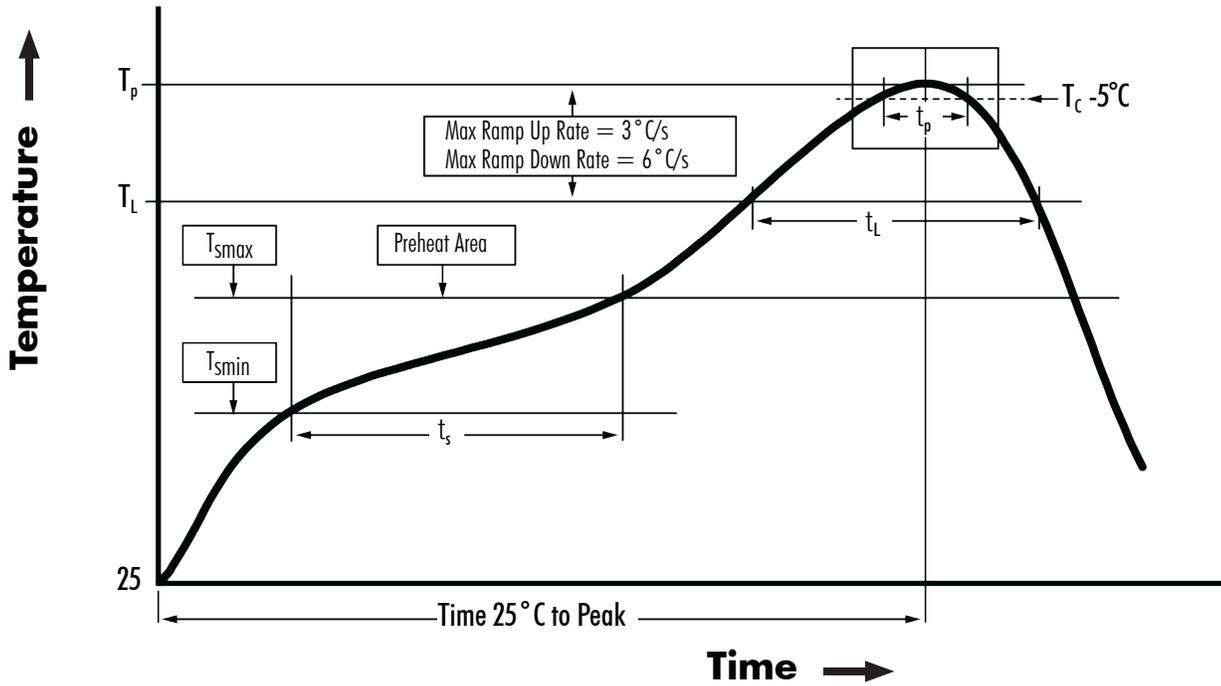
TOP VIEW



PCB PAD PATTERN (REFERENCE ONLY)



**Recommended Reflow Profile (Based on J-STD-020D)**



$T_{S_{MIN}}$ (°C)	$T_{S_{MAX}}$ (°C)	$T_L$ (°C)	$T_P$ (°C MAX)	$t_s$ (s)	$t_L$ (s)	$t_p$ (s MAX)	Ramp-up rate ( $T_L$ to $T_P$ )	Ramp-down rate ( $T_P$ to $T_L$ )	Time 25°C to peak temperature (s MAX)
100	150	183	235	60 - 120	60 - 150	20	3°C/s MAX	6°C/s MAX	360

**NOTES:**

1. All temperatures measured on the package leads.
2. Maximum number of reflow cycles not to exceed 2.

